



TPS SERIES 30MM

500 - 1400 V_{RRM} , 700 A_{AVG}
Standard Recovery Thyristor

Features:

- All Diffused Structure
- Center Amplifying Gate Configuration
- Blocking capability up to 1400 volts
- Guaranteed Maximum Turn-Off Time
- High dV/dt Capability
- Pressure Assembled Device



ELECTRICAL CHARACTERISTICS AND RATINGS

Blocking - Off State

Device Type	$V_{RRM}^{(1)}$	$V_{DRM}^{(1)}$	$V_{RSM}^{(1)}$
T30P700S500	500	500	600
T30P700S600	600	600	720
T30P700S800	800	800	960
T30P700S1000	1000	1000	1150
T30P700S1200	1200	1200	1300
T30P700S1400	1400	1400	1500

V_{RRM} = Repetitive peak reverse voltage

V_{DRM} = Repetitive peak off state voltage

V_{RSM} = Non repetitive peak reverse voltage⁽²⁾

Repetitive peak reverse leakage and off state leakage	I_{RRM} / I_{DRM}	15 mA 30 mA ⁽³⁾
Critical rate of voltage rise ⁽⁴⁾	dV/dt	200 V/ μ sec

Conducting - On State

Parameter	Symbol	Min.	Max.	Typ.	Units	Conditions
Average value of on-state current	$I_{T(AV)}$		700		A	Sinewave, 180° conduction, $T_c = 65^\circ C$
RMS value of on-state current	I_{TRMS}		1000		A	Nominal value
Peak one cycle surge (non-repetitive) current	I_{TSM}		8000		A	8.3 msec (60Hz), sinusoidal wave-shape, 180° conduction, $T_j = 125^\circ C$
			7400		A	10.0 msec (50Hz), sinusoidal wave-shape, 180° conduction, $T_j = 125^\circ C$
I square t	I^2t		265000		A ² s	8.3 msec and 10.0 msec
Latching current	I_L		800		mA	$V_D = 24 V$; $R_L = 12$ ohms
Holding current	I_H		400		mA	$V_D = 24 V$; $I = 2.5 A$

Notes:

All ratings are specified for $T_j = 25^\circ C$ unless otherwise stated.

(1) All voltage ratings are specified for an applied 50Hz/60Hz sinusoidal waveform over the temperature range -40 to $+125^\circ C$.

(2) 10 msec. max. pulse width

(3) Maximum value for $T_j = 125^\circ C$.

(4) Minimum value for linear and exponential wave shape to 80% rated V_{DRM} . Gate open. $T_j = 125^\circ C$.

(5) Non-repetitive value.

(6) The value of di/dt is established in accordance with EIA/NIMA Standard RS-397, Section 5-2-2-6. The value defined would be in addition to that obtained from a snubber circuit, comprising a 0.2 μF capacitor and 20 ohms resistance in parallel with the thyristor under test.



Peak on-state voltage	V_{TM}		2.20		V	$I_{TM} = 2000 \text{ A}$; Duty cycle $\leq 0.01\%$
Critical rate of rise of on-state current ^(5, 6)	di/dt		400		A/ μs	Switching from $V_{DRM} \leq 1000 \text{ V}$, non-repetitive
Critical rate of rise of on-state current ⁽⁶⁾	di/dt		150		A/ μs	Switching from $V_{DRM} \leq 1000 \text{ V}$

Gating

Parameter	Symbol	Min.	Max.	Typ.	Units	Conditions
Peak gate power dissipation	P_{GM}		200		W	$t_p = 40 \text{ us}$
Average gate power dissipation	$P_{G(AV)}$		5		W	
Peak gate current	I_{GM}		10		A	
Gate current required to trigger all units	I_{GT}		300 150 125		mA mA mA	$V_D = 6 \text{ V}; R_L = 3 \text{ ohms}; T_J = -40^\circ\text{C}$ $V_D = 6 \text{ V}; R_L = 3 \text{ ohms}; T_J = +25^\circ\text{C}$ $V_D = 6 \text{ V}; R_L = 3 \text{ ohms}; T_J = +125^\circ\text{C}$
Gate voltage required to trigger all units	V_{GT}	0.15	5 3		V V V	$V_D = 6 \text{ V}; R_L = 3 \text{ ohms}; T_J = -40^\circ\text{C}$ $V_D = 6 \text{ V}; R_L = 3 \text{ ohms}; T_J = 0-125^\circ\text{C}$ $V_D = \text{Rated } V_{DRM}; R_L = 1000 \text{ ohms}; T_J = +125^\circ\text{C}$
Peak negative voltage	V_{GRM}		5		V	

Dynamic

Parameter	Symbol	Min.	Max.	Typ.	Units	Conditions
Delay time	t_d		1.5	0.7	μs	$I_{TM} = 50 \text{ A}; V_D = \text{Rated } V_{DRM}$ Gate pulse: $V_G = 20 \text{ V}; R_G = 20 \text{ ohms}; t_r = 0.1 \mu\text{s}; t_p = 20 \mu\text{s}$
Turn-off time (with $V_R = -50 \text{ V}$)	t_q		200	125	μs	$I_{TM} = 500 \text{ A}; di/dt = 25 \text{ A}/\mu\text{s}; V_R \geq -50 \text{ V}; \text{Re-applied } dV/dt = 20 \text{ V}/\mu\text{s}$ linear to $80\% V_{DRM}; V_G = 0; T_J = 125^\circ\text{C}; \text{Duty cycle} \geq 0.01\%$
Reverse recovery charge	Q_{rr}		*		μC	$I_{TM} = 500 \text{ A}; di/dt = 25 \text{ A}/\mu\text{s}; V_R \geq -50 \text{ V}$

* For guaranteed max. value, contact factory.



THERMAL AND MECHANICAL CHARACTERISTICS AND RATINGS

Parameter	Symbol	Min.	Max.	Typ.	Units	Conditions
Operating temperature	T _J	-40	+125		°C	
Storage temperature	T _{STG}	-40	+150		°C	
Thermal resistance – junction to case	R _{θ(j-c)}	0.045 (1)	0.055 (2)		°C/W	Double sided cooled * (1) @ 2000 lb.; (2) @ 800 lb.
Thermal resistance – junction to case	R _{θ(j-c)}	0.090 (1)	0.110 (2)		°C/W	Single sided cooled * (1) @ 2000 lb.; (2) @ 800 lb.
Thermal resistance – case to sink	R _{θ(c-s)}		.030 .060		°C/W	Double sided cooled * Single sided cooled *
Mounting force	P	800 3.6	2500 11.1		lb. kN	
Weight	W			2.5 70	oz. g	

* Mounting surfaces smooth, flat and greased

CASE OUTLINE AND DIMENSIONS

